- 27 -

## WHAT IS CLAIMED IS:

- 1. A power semiconductor device, comprising:
- a first semiconductor layer of a first
  conductivity type;

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- a second semiconductor layer of the first conductivity type and a third semiconductor layer of a second conductivity type which are alternately and laterally arranged on the first semiconductor layer;
- a first main electrode electrically in contact

  with the first semiconductor layer;
  - a fourth semiconductor layer of the second conductivity type selectively formed in surface regions of the second and third semiconductor layers;
  - a fifth semiconductor layer of the first conductivity type selectively formed in a surface region of the fourth semiconductor layer;
  - a second main electrode formed in contact with surfaces of the fourth and fifth semiconductor layers; and
- a control electrode formed on surfaces of the second, fourth and fifth semiconductor layers,

wherein an impurity concentration of the first semiconductor layer is lower than that of the second semiconductor layer; and a layer thickness ratio A is given by an expression:

 $0 < A = t/(t+d) \le 0.72$ 

where t is a thickness of the first semiconductor layer,

and d is a thickness of the second semiconductor layer.

2. A semiconductor device according to claim 1, wherein, assuming that an aspect ratio B is represented by B = d/w, where w is an interval between adjacent third semiconductor layers, the layer thickness ratio A and the aspect ratio B satisfy an expression below:

$$A \times B \leq 1.15$$

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- 3. A semiconductor device according to claim 1, wherein an aspect ratio B and the layer thickness ratio A satisfy an expression below:
  - $-0.04B + 0.48 < (A \times B) < 0.13B + 0.59$  where the aspect ratio B is represented by B = d/w, and w is an interval between adjacent third semiconductor layers.
- 4. A semiconductor device according to claim 1, wherein a product of  $A \times B$  satisfies a relationship below:

$$0.58 < (A \times B) < 0.71$$

- wherein B denotes the an aspect ratio represented by B

  20 = d/w, where w is an interval between adjacent third
  semiconductor layers.
  - 5. A semiconductor device according to claim 2, wherein, assuming that a breakdown voltage is represented by VB (V), then t, VB (V), B and A satisfy a relationship below:

$$t < 2.53 \times 10^{-6} \times (A \times VB)^{7/6}$$
 (cm).

6. A semiconductor device according to claim 3,

wherein, assuming that an impurity concentration of the first semiconductor layer is represented by Nn and that a breakdown voltage is represented by VB (V), then Nn, VB (V), and A satisfy the relationship below:

 $Nn > 1.11 \times 10^{18} \times (A \times VB)^{-4/3} \text{ (cm}^{-3)}.$ 

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- 7. A semiconductor device according to claim 1, wherein an insulating material is interposed between the second semiconductor layer and the third semiconductor layer.
- 8. A semiconductor device according to claim 7, wherein a void is present in said insulating material.
  - 9. A semiconductor device according to claim 1, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.
  - 10. A semiconductor device according to claim 2, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.
  - 11. A semiconductor device according to claim 3, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.
- 12. A semiconductor device according to claim 4,
  25 wherein an impurity concentration profile of at least
  one of the second semiconductor layer and the third
  semiconductor layer gradually reduces with depth.

- 13. A semiconductor device according to claim 5, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.
- 14. A semiconductor device according to claim 6, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.

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- 15. A semiconductor device according to claim 7, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.
- 16. A semiconductor device according to claim 8, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.
- 17. A semiconductor device according to claim 1, wherein a void is present in a border region between the second semiconductor layer and the third semiconductor layer.
- 18. A semiconductor device according to claim 17, wherein a plurality of voids are present independently along the border region.
- 19. A semiconductor device according to claim 17, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.

20. A semiconductor device according to claim 18, wherein an impurity concentration profile of at least one of the second semiconductor layer and the third semiconductor layer gradually reduces with depth.